



BUK6D43-40P

40 V, P-channel Trench MOSFET

20 December 2017

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a medium power DFN2020MD-6 (SOT1220) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Extended temperature range $T_j = 175\text{ °C}$
- Side wettable flanks for optical solder inspection
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Trench MOSFET technology
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

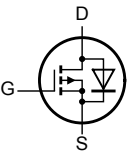
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$T_j = 25\text{ °C}$	-	-	-40	V
V_{GS}	gate-source voltage		-20	-	20	V
I_D	drain current	$V_{GS} = -10\text{ V}; T_{sp} = 25\text{ °C}$	-	-	-14	A
P_{tot}	total power dissipation	$T_{sp} = 25\text{ °C}$	-	-	15	W
Static characteristics						
R_{DSon}	drain-source on-state resistance	$V_{GS} = -10\text{ V}; I_D = -6\text{ A}; T_j = 25\text{ °C}$	-	30	43	mΩ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain	 Transparent top view DFN2020MD-6 (SOT1220)	 017aaa094
2	D	drain		
3	G	gate		
4	S	source		
5	D	drain		
6	D	drain		
7	D	drain		
8	S	source		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK6D43-40P	DFN2020MD-6	DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1220

7. Marking

Table 4. Marking codes

Type number	Marking code
BUK6D43-40P	4D

8. Limiting values

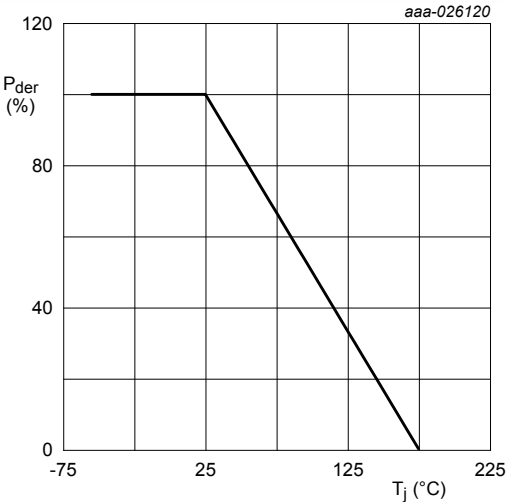
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DS}	drain-source voltage	$T_j = 25\text{ }^{\circ}\text{C}$		-	-40	V
V_{GS}	gate-source voltage			-20	20	V
I_D	drain current	$V_{GS} = -10\text{ V}; T_{sp} = 25\text{ }^{\circ}\text{C}$		-	-14	A
		$V_{GS} = -10\text{ V}; T_{sp} = 100\text{ }^{\circ}\text{C}$		-	-8.9	A
		$V_{GS} = -10\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	-6	A
I_{DM}	peak drain current	$T_{sp} = 25\text{ }^{\circ}\text{C}$; single pulse; $t_p \leq 10\text{ }\mu\text{s}$		-	-56	A
P_{tot}	total power dissipation	$T_{sp} = 25\text{ }^{\circ}\text{C}$		-	15	W
		$T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	2.3	W
T_j	junction temperature			-55	175	$^{\circ}\text{C}$
T_{amb}	ambient temperature			-55	175	$^{\circ}\text{C}$
T_{stg}	storage temperature			-65	175	$^{\circ}\text{C}$
Source-drain diode						
I_S	source current	$T_{sp} = 25\text{ }^{\circ}\text{C}$		-	-14	A
		$T_{amb} = 25\text{ }^{\circ}\text{C}$	[1]	-	-2.3	A
I_{SM}	peak source current	single pulse; $t_p = 10\text{ }\mu\text{s}$; $T_{sp} = 25\text{ }^{\circ}\text{C}$		-	-56	A
ESD maximum rating						
V_{ESD}	electrostatic discharge voltage	HBM	[2]	-	1000	V
Avalanche ruggedness						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$T_{j(\text{init})} = 25\text{ }^{\circ}\text{C}$; $I_D = -1.4\text{ A}$; DUT in avalanche (unclamped)		-	29.7	mJ

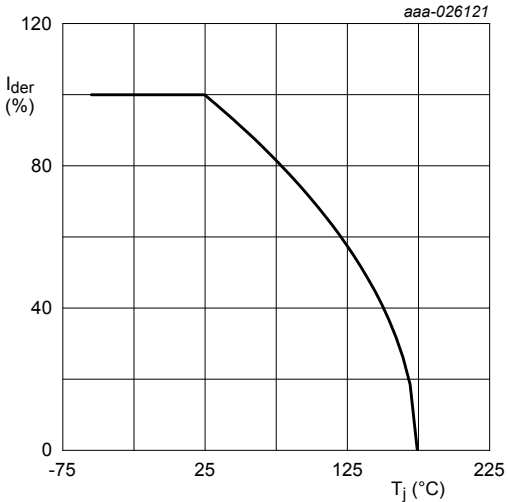
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm^2 .

[2] Measured between all pins.



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100 \%$$

Fig. 1. Normalized total power dissipation as a function of junction temperature



$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100 \%$$

Fig. 2. Normalized continuous drain current as a function of junction temperature

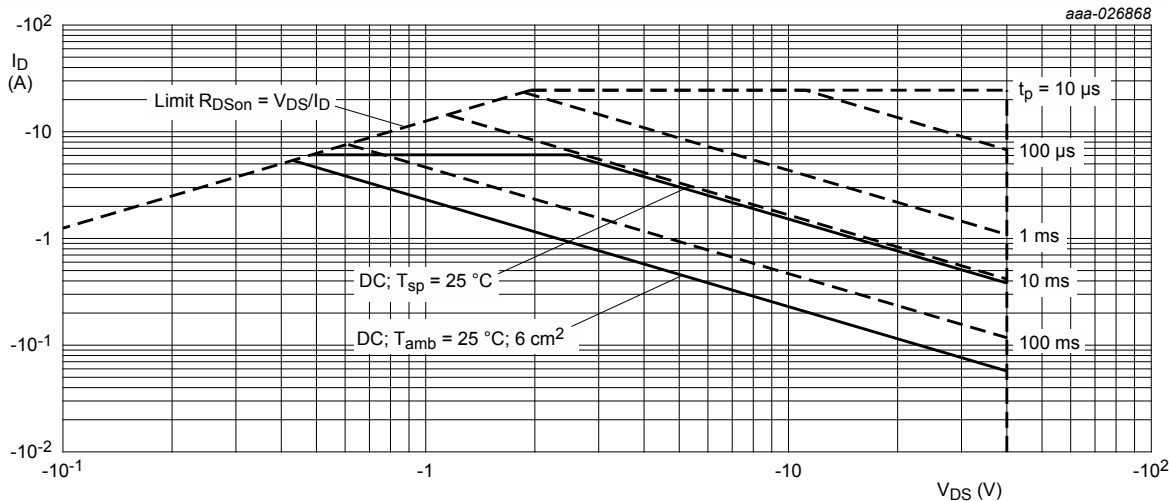


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	57	66	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	6	10	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².

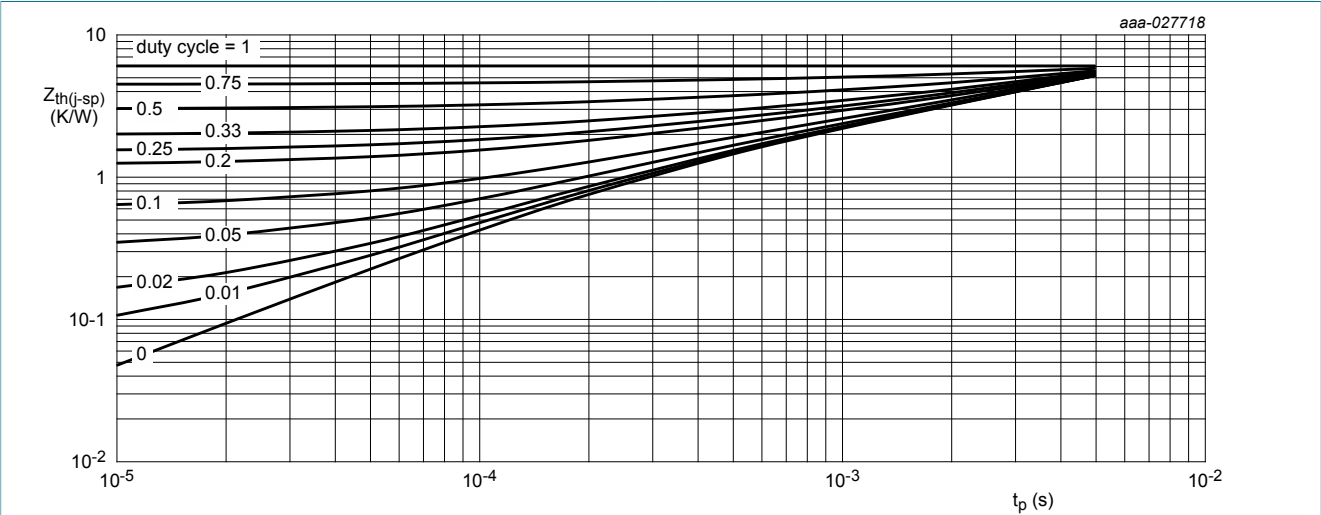
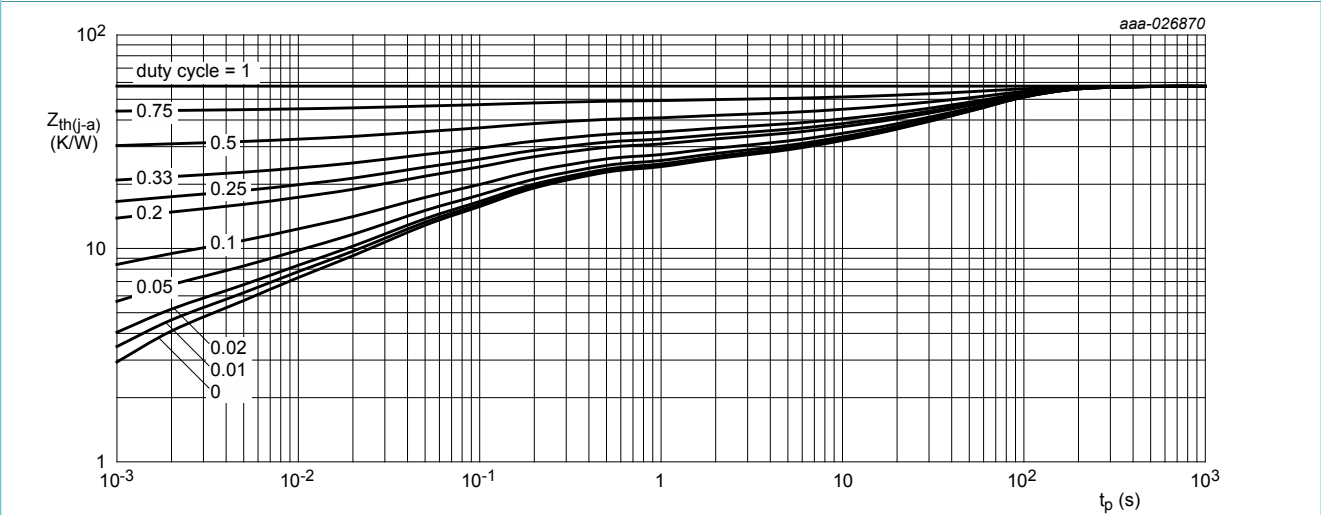


Fig. 4. Transient thermal impedance from junction to solder point as a function of pulse duration; typical values



FR4 PCB, mounting pad for drain 6 cm²

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V _{(BR)DSS}	drain-source breakdown voltage	I _D = -250 μA; V _{GS} = 0 V; T _j = 25 °C		-40	-	-	V
V _{GSth}	gate-source threshold voltage	I _D = -250 μA; V _{DS} =V _{GS} ; T _j = 25 °C		-1.4	-2	-2.7	V
I _{DSS}	drain leakage current	V _{DS} = -40 V; V _{GS} = 0 V; T _j = 25 °C		-	-	-1	μA
		V _{DS} = -40 V; V _{GS} = 0 V; T _j = 175 °C		-	-	-500	μA
I _{GSS}	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C		-	-	-100	nA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C		-	-	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = -10 V; I _D = -6 A; T _j = 25 °C		-	30	43	mΩ
		V _{GS} = -10 V; I _D = -6 A; T _j = 175 °C		-	57	81	mΩ
		V _{GS} = -4.5 V; I _D = -4.1 A; T _j = 25 °C		-	45	70	mΩ
g _{fs}	forward transconductance	V _{DS} = -10 V; I _D = -5 A; T _j = 25 °C		-	33	-	S
R _G	gate resistance	f = 1 MHz		-	6	-	Ω
Dynamic characteristics							
Q _{G(tot)}	total gate charge	V _{DS} = -20 V; I _D = -5 A; V _{GS} = -10 V; T _j = 25 °C		-	24	36	nC
Q _{GS}	gate-source charge			-	4.2	-	nC
Q _{GD}	gate-drain charge			-	5.4	-	nC
C _{iss}	input capacitance	V _{DS} = -20 V; f = 1 MHz; V _{GS} = 0 V; T _j = 25 °C		-	1260	-	pF
C _{oss}	output capacitance			-	106	-	pF
C _{rss}	reverse transfer capacitance			-	91	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = -20 V; I _D = -5 A; V _{GS} = -10 V; R _{G(ext)} = 6 Ω; T _j = 25 °C		-	9	-	ns
t _r	rise time			-	23	-	ns
t _{d(off)}	turn-off delay time			-	35	-	ns
t _f	fall time			-	14	-	ns
Source-drain diode							
V _{SD}	source-drain voltage	I _S = -2.3 A; V _{GS} = 0 V; T _j = 25 °C		-	-0.8	-1.2	V
t _{rr}	reverse recovery time	I _S = -2.3 A; dI _S /dt = 100 A/μs; V _{GS} = 0 V; V _{DS} = -20 V; T _j = 25 °C		-	15.6	-	ns
Q _r	recovered charge			-	8	-	nC

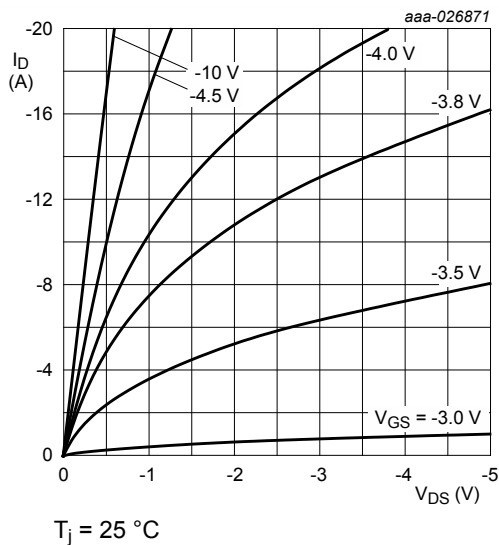


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

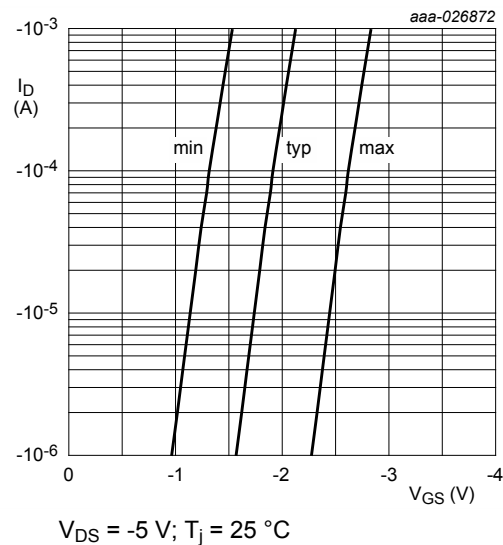


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

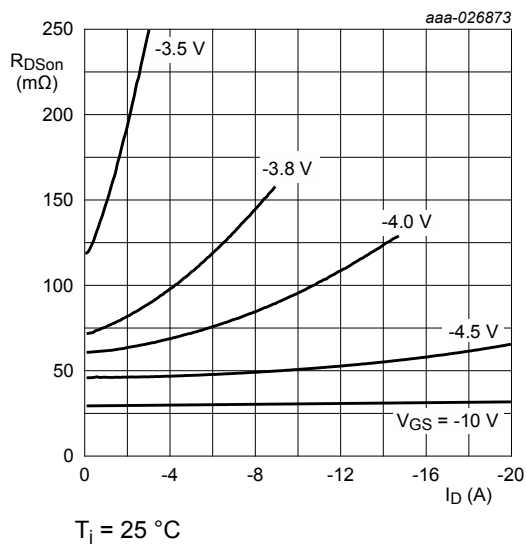


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

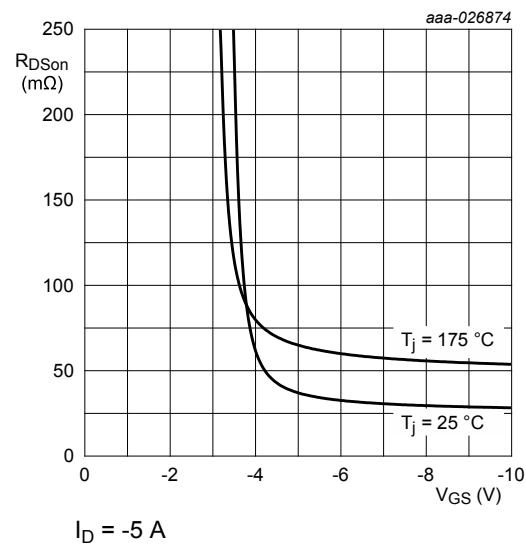


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

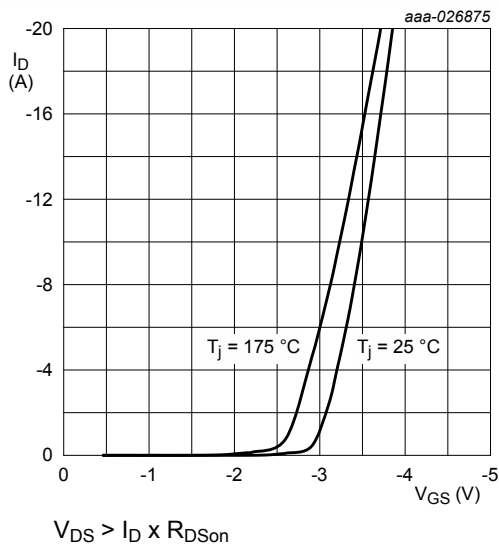


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

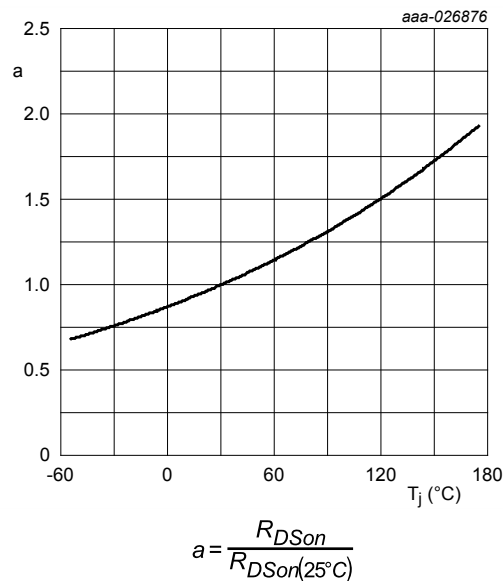


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

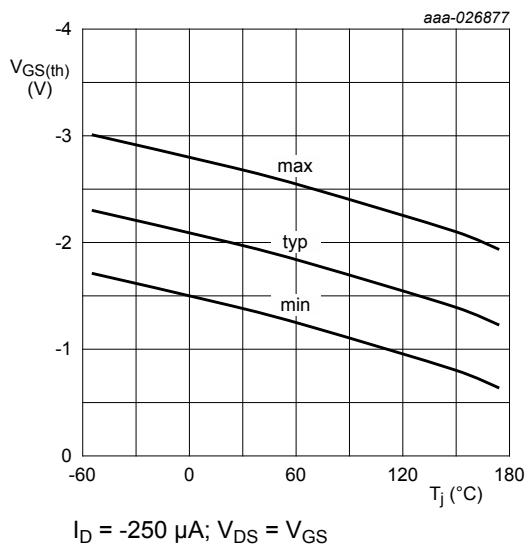


Fig. 12. Gate-source threshold voltage as a function of junction temperature

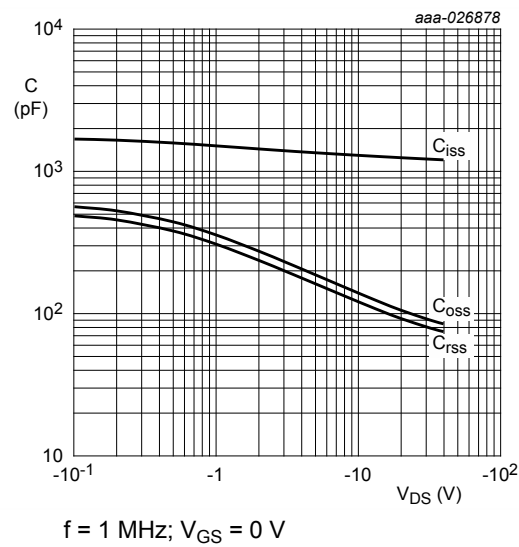


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

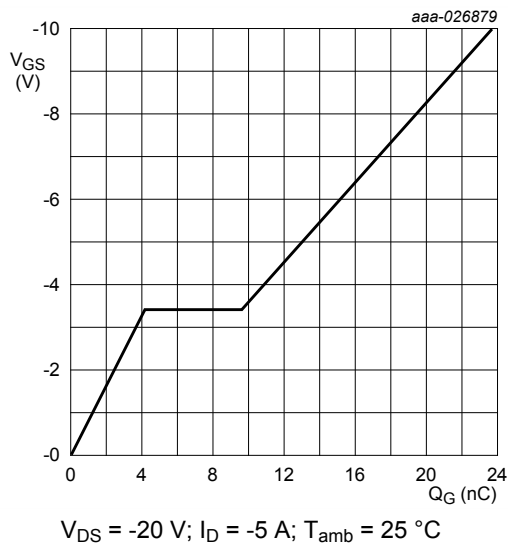


Fig. 14. Gate-source voltage as a function of gate charge; typical values

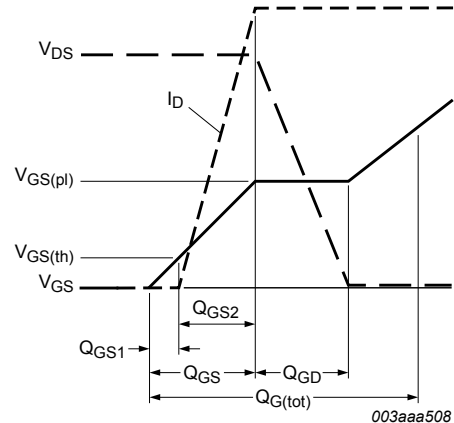


Fig. 15. Gate charge waveform definitions

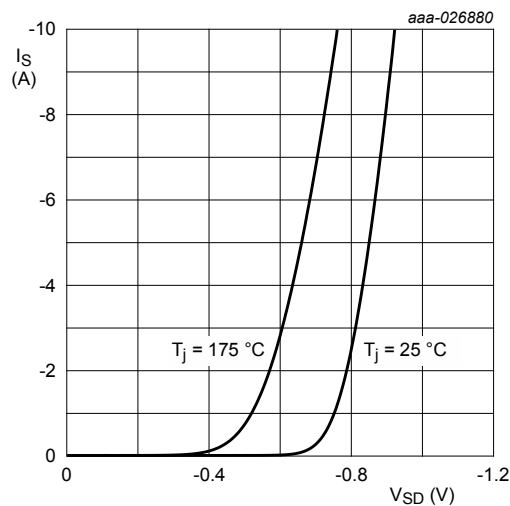


Fig. 16. Source current as a function of source-drain voltage; typical values

11. Test information

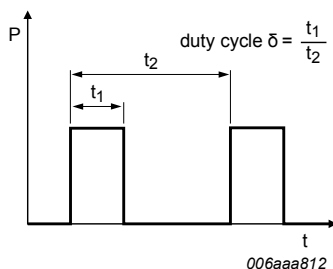


Fig. 17. Duty cycle definition

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads;
6 terminals; body 2 x 2 x 0.65 mm

SOT1220

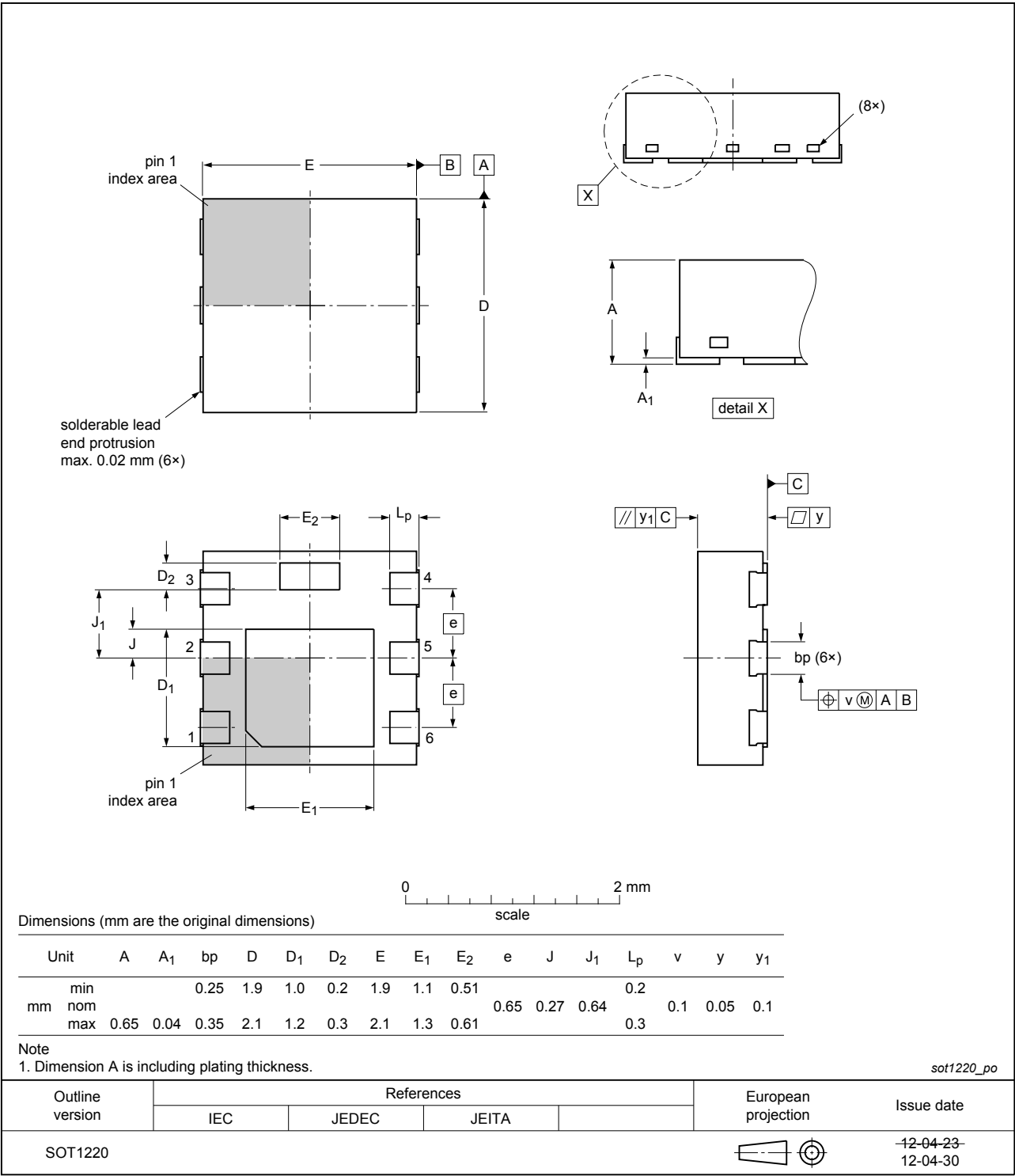


Fig. 18. Package outline DFN2020MD-6 (SOT1220)

13. Soldering

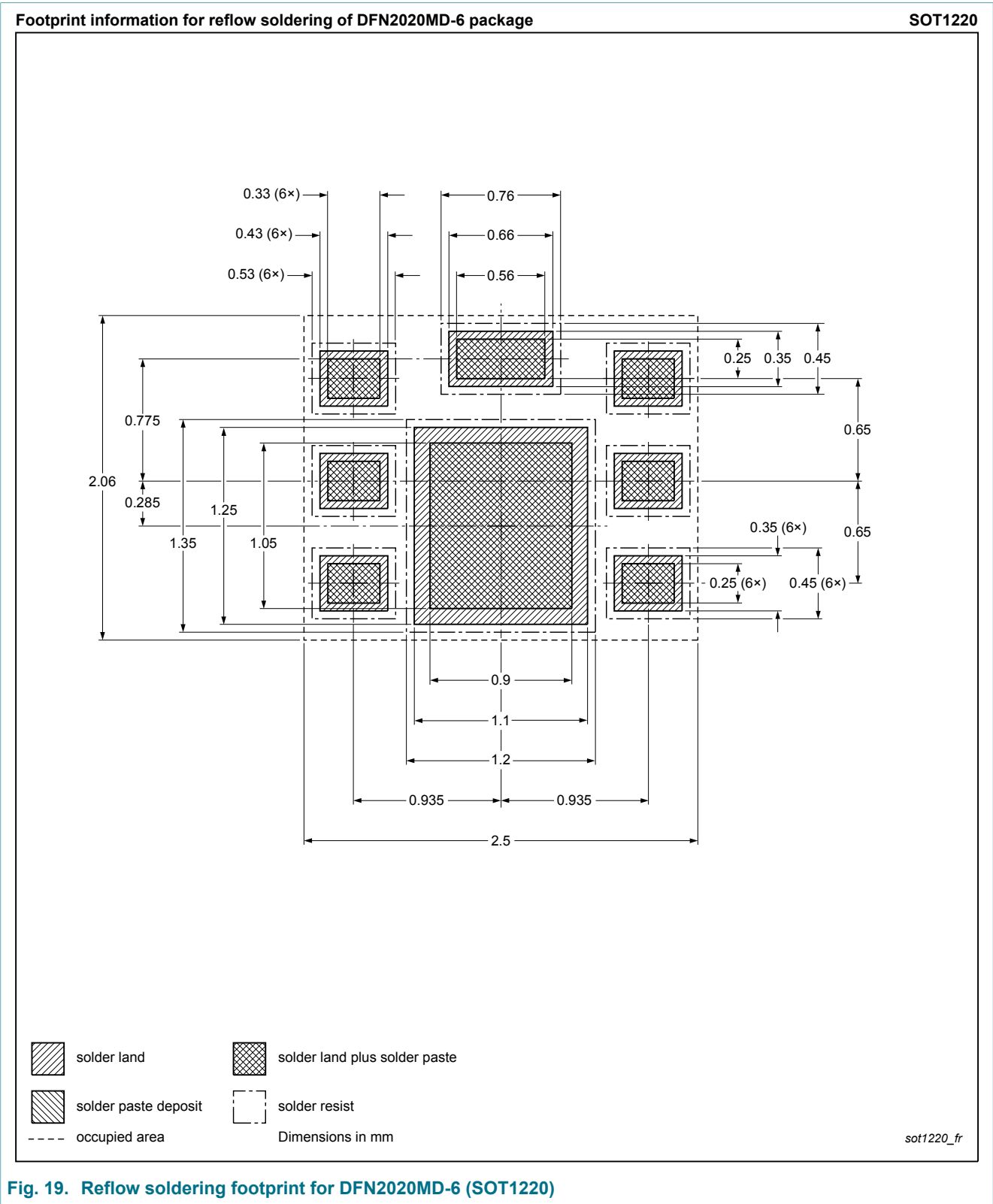


Fig. 19. Reflow soldering footprint for DFN2020MD-6 (SOT1220)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BUK6D43-40P v.2	20171220	Product data sheet	-	BUK6D43-40P v.1
Modifications:	Characteristics, temperature condition changed for drain leakage current.			
BUK6D43-40P v.1	20171214	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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